

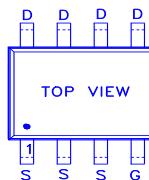
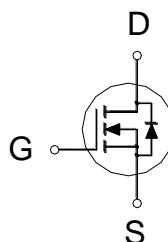
NIKO-SEM
**N-Channel Enhancement Mode
Field Effect Transistor**
PP9H06BV

SOP-8

Halogen-Free & Lead-Free

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
60V	9.8mΩ	10.6A


 G. GATE
 D. DRAIN
 S. SOURCE

 100% UIS Tested
 100% Rg Tested
ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	60	V
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current	$T_A = 25^\circ\text{C}$	I_D	10.6	A
	$T_A = 70^\circ\text{C}$		8.9	
Pulsed Drain Current ¹		I_{DM}	50	
Avalanche Current		I_{AS}	27	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	36	mJ
Power Dissipation ³	$T_A = 25^\circ\text{C}$	P_D	2.4	W
	$T_A = 70^\circ\text{C}$		1.7	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 175	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE		SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient ²	$t \leq 10\text{s}$	$R_{\theta JA}$		62.5	°C / W
Junction-to-Ambient ²	Steady-State	$R_{\theta JA}$		75	

¹Pulse width limited by maximum junction temperature.²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.³The Power dissipation is based on $R_{\theta JA} t \leq 10\text{s}$ value.**ELECTRICAL CHARACTERISTICS ($T_j = 25^\circ\text{C}$, Unless Otherwise Noted)**

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	60			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1	2	3	

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Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 60V, V_{GS} = 0V$			1	μA
		$V_{DS} = 60V, V_{GS} = 0V, T_J = 55^\circ C$			10	
Drain-Source On-State Resistance ¹	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 5A$		7.9	9.8	$m\Omega$
		$V_{GS} = 4.5V, I_D = 5A$		12.4	15	
Forward Transconductance ¹	g_{fs}	$V_{DS} = 5V, I_D = 5A$		22		S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 30V, f = 1MHz$		1155		pF
Output Capacitance	C_{oss}			571		
Reverse Transfer Capacitance	C_{rss}			20		
Gate Resistance	R_g	$V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$		1		Ω
Total Gate Charge ²	Q_g	$V_{DS} = 30V, V_{GS} = 10V, I_D = 5A$		17.6		nC
				9.2		
Gate-Source Charge ²	Q_{gs}			2.9		
Gate-Drain Charge ²	Q_{gd}			3.7		
Turn-On Delay Time ²	$t_{d(on)}$	$V_{DS} = 30V, I_D \approx 5A, V_{GS} = 10V, R_{GEN} = 6\Omega$		9.3		nS
Rise Time ²	t_r			18		
Turn-Off Delay Time ²	$t_{d(off)}$			23		
Fall Time ²	t_f			31		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ C$)						
Continuous Current	I_S				2	A
Forward Voltage ¹	V_{SD}	$I_F = 2A, V_{GS} = 0V$			1.2	V
Reverse Recovery Time	t_{rr}	$I_F = 2A, dI_F/dt = 100A/\mu S$		52		nS
Reverse Recovery Charge	Q_{rr}			35		nC

¹Pulse test : Pulse Width $\leq 300 \mu sec$, Duty Cycle $\leq 2\%$.

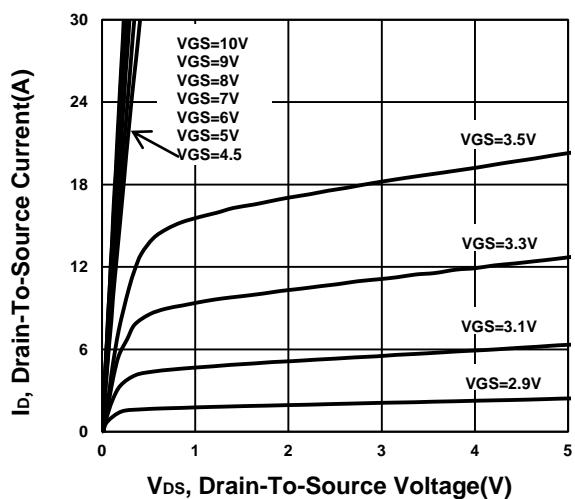
²Independent of operating temperature.

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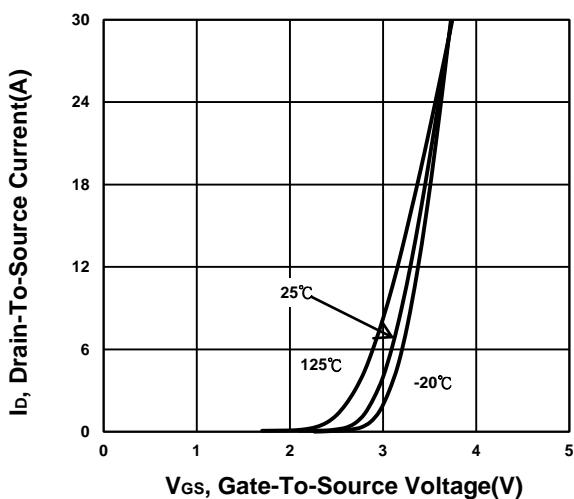
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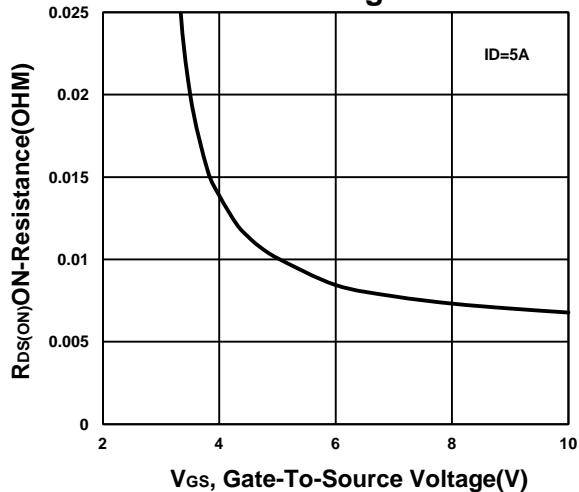
Output Characteristics



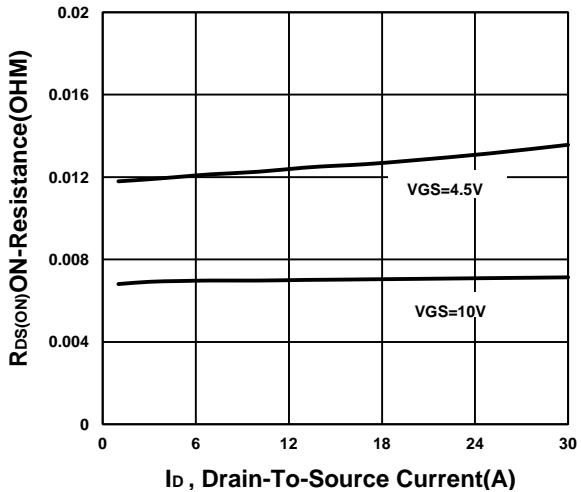
Transfer Characteristics



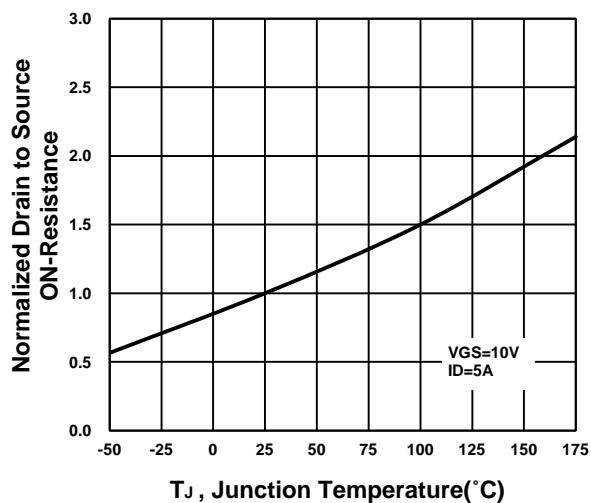
On-Resistance VS Gate-To-Source Voltage



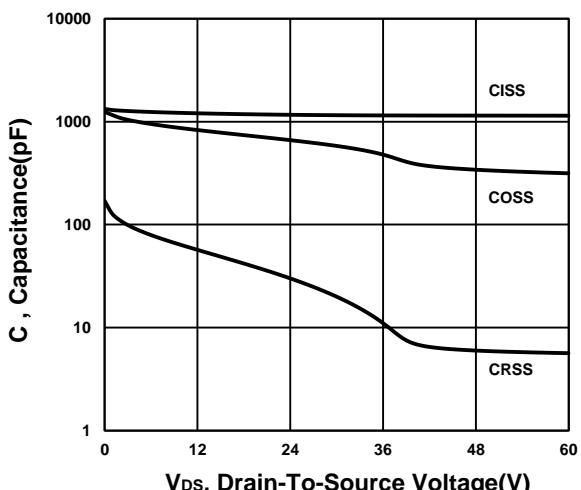
On-Resistance VS Drain Current

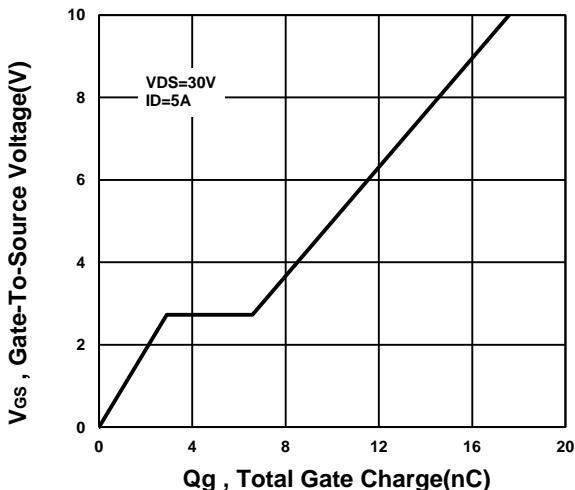
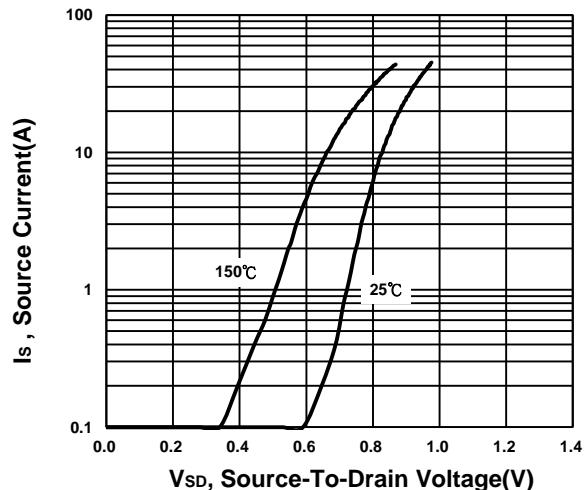
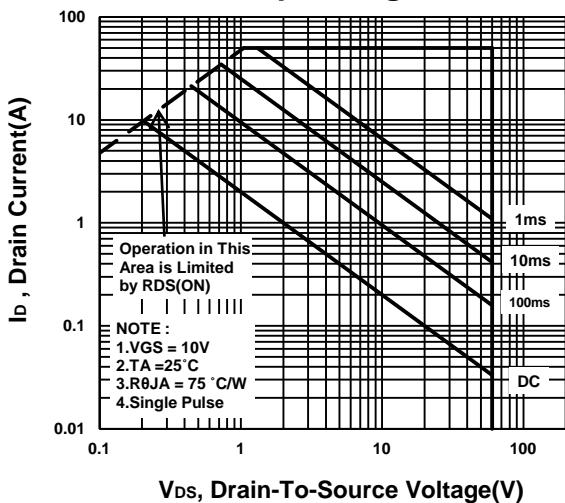
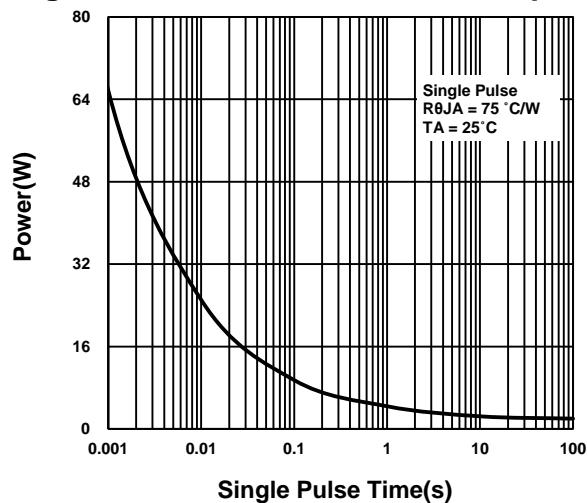


On-Resistance VS Temperature



Capacitance Characteristic



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Halogen-Free & Lead-Free****Gate charge Characteristics****Source-Drain Diode Forward Voltage****Safe Operating Area****Single Pulse Maximum Power Dissipation****Transient Thermal Response Curve**